Unit: mm

TOSHIBA Diode Silicon Epitaxial Planar Diode

# **1SS398**

### High-Voltage, High-Speed Switching Applications

• Low forward voltage:  $V_F = 1.0 \text{ V (typ.)} @ I_F = 100 \text{ mA}$ 

• Fast reverse recovery time:  $t_{rr} = 0.5 \mu s$  (typ.) • Small total capacitance:  $C_T = 2.5 \mu s$  (typ.)

• Small package: SC-59

### Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse Voltage	$V_{RM}$	420	V
Reverse voltage	V <sub>R</sub>	400	V
Maximum (peak) forward current	I <sub>FM</sub>	300 *	mA
Average forward current	Io	100 *	mA
Surge current (10ms)	I <sub>FSM</sub>	2 *	Α
Power dissipation	Р	150	mW
Junction temperature	Tj	125	°C
Storage temperature range	T <sub>stg</sub>	−55 to 125	°C

2.5 - 0.3 +0.25 1.5 - 0.15 1. ANODE 1 2. CATHODE 2 S-MINI 3. ANODE 2, CATHODE 1 JEDEC TO-236MOD JEITA SC-59 TOSHIBA 1-3G1G

Weight: 12 mg (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in

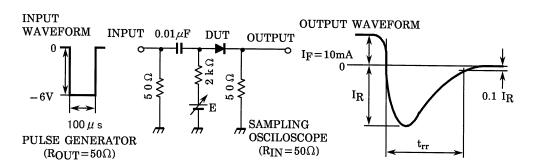
temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

\*: Unit rating. Total rating = unit rating × 0.7

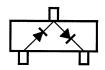
### **Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V <sub>F (1)</sub>	_	I <sub>F</sub> = 10 mA	_	0.8	_	· V
	V <sub>F (2)</sub>	_	I <sub>F</sub> = 100 mA	_	1.0	1.3	
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 300 V	_	_	0.05	μΑ
	I <sub>R (2)</sub>	_	V <sub>R</sub> = 400 V	_	_	0.1	
Total capacitance	C <sub>T</sub>	_	V <sub>R</sub> = 0 V, f = 1 MH <sub>z</sub>	_	2.5	5.0	pF
Reverse recovery time	t <sub>rr</sub>	_	$I_F = 10 \text{ mA}$ (Fig.1)	_	0.5	_	μs

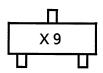
# Fig.1 Reverse Recovery Time (t<sub>rr</sub>) Test Circuit

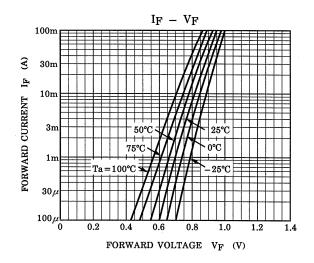


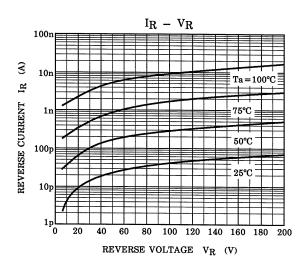
## **Equivalent Circuit (Top View)**

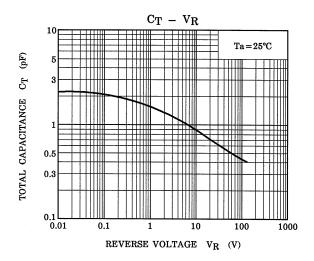


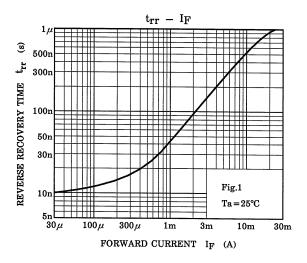
### Marking

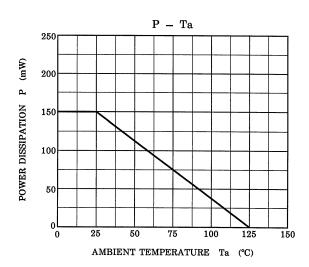












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